

**Voltage Detector IC Series**

# Low Voltage Free Delay Time Setting CMOS Voltage Detector IC Series

**BU42xx series BU43xx series**
**●General Description**

ROHM's BU42xx and BU43xx series are CMOS Voltage Detector ICs with adjustable output delay. It is a high-accuracy, low current consumption Voltage Detector IC series with a built-in delay circuit. The lineup was established with two output types (Nch open drain and CMOS output) and detection voltages range from 0.9V to 4.8V in increments of 0.1V, so that the series may be selected according to application.

**●Features**

- Delay Time Controlled by external Capacitor
- Two output types (Nch open drain and CMOS output)
- Ultra-low current consumption
- Wide operating temperature range
- Very small and low height package
- Package SSOP5 and SOP4 is similar to SOT-23-5 and SC-82 respectively (JEDEC)

**●Key Specifications**

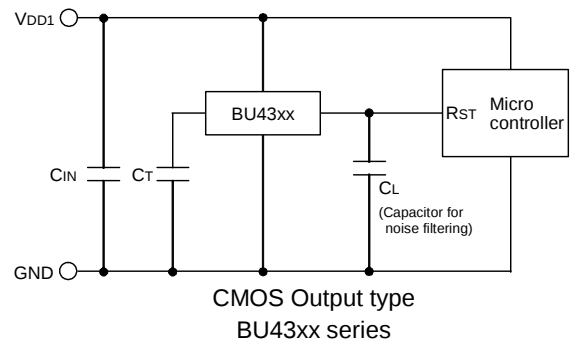
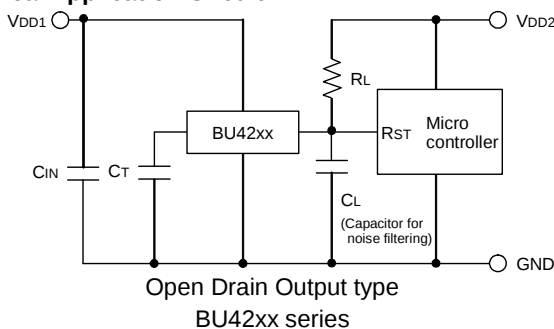
- Detection voltage: 0.9V to 4.8V (Typ.)  
0.1V steps
- High accuracy detection voltage:  $\pm 1.0\%$
- Ultra-low current consumption: 0.55 $\mu$ A (Typ.)
- Operating temperature range: -40°C to +125°C

**●Package**

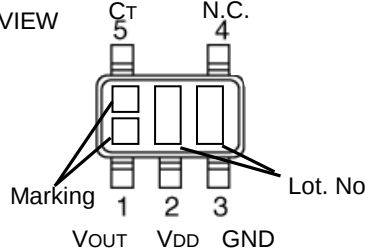
- SSOP5:  2.90mm x 2.80mm x 1.25mm
- SOP4:  2.00mm x 2.10mm x 0.95mm
- VSOF5:  1.60mm x 1.60mm x 0.60mm

**●Applications**

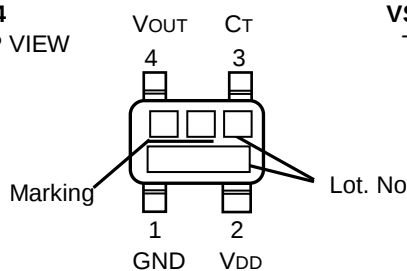
Circuits using microcontrollers or logic circuits that require a reset.

**●Typical Application Circuit**

**●Connection Diagram & Pin Descriptions**
**SSOP5**

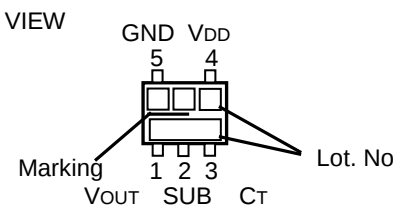
TOP VIEW


**SOP4**

TOP VIEW


**VSOF5**

TOP VIEW



| PIN No. | Symbol | Function                                            |
|---------|--------|-----------------------------------------------------|
| 1       | VOUT   | Reset output                                        |
| 2       | VDD    | Power supply voltage                                |
| 3       | GND    | GND                                                 |
| 4       | N.C.   | Unconnected terminal                                |
| 5       | CT     | Capacitor connection terminal for output delay time |

| PIN No. | Symbol | Function                                            |
|---------|--------|-----------------------------------------------------|
| 1       | GND    | GND                                                 |
| 2       | VDD    | Power supply voltage                                |
| 3       | CT     | Capacitor connection terminal for output delay time |
| 4       | VOUT   | Reset output                                        |

| PIN No. | Symbol | Function                                            |
|---------|--------|-----------------------------------------------------|
| 1       | VOUT   | Reset output                                        |
| 2       | SUB    | Substrate*                                          |
| 3       | CT     | Capacitor connection terminal for output delay time |
| 4       | VDD    | Power supply voltage                                |
| 5       | GND    | GND                                                 |

\*Connect the substrate to VDD

○Product structure : Silicon monolithic integrated circuit

○This product is not designed for protection against radioactive rays

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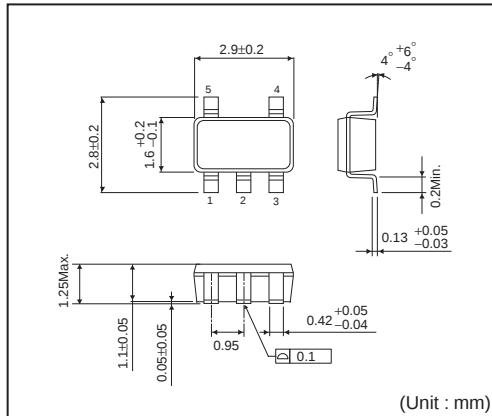
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## ●Ordering Information

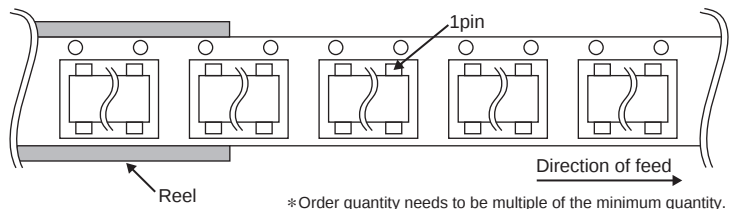
| B U X X X X X |                                             |  |                                                              |  |                                                 | - | T R                                                                |  |
|---------------|---------------------------------------------|--|--------------------------------------------------------------|--|-------------------------------------------------|---|--------------------------------------------------------------------|--|
| Part Number   | Output Type<br>42 : Open Drain<br>43 : CMOS |  | Reset Voltage Value<br>09 : 0.9V<br>↓ 0.1V step<br>48 : 4.8V |  | Package<br>G : SSOP5<br>F : SOP4<br>FVE : VSOF5 |   | Packaging and forming specification<br>TR : Embossed tape and reel |  |

## SSOP5

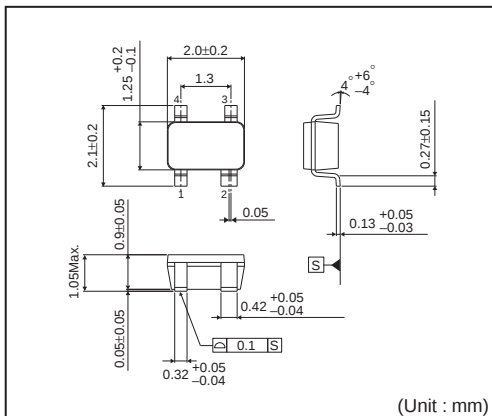


## &lt;Tape and Reel information&gt;

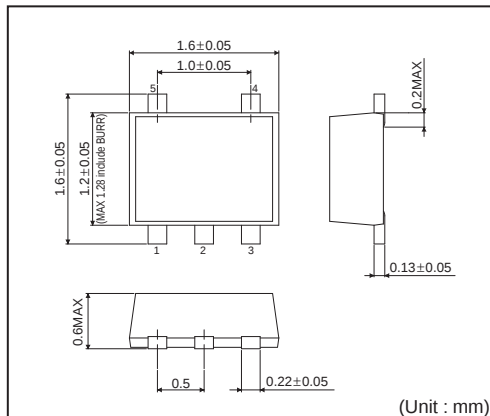
|                   |                                                                                                                                                    |
|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|
| Tape              | Embossed carrier tape                                                                                                                              |
| Quantity          | 3000pcs                                                                                                                                            |
| Direction of feed | TR<br>(The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand) |



## SOP4



## VSOF5



## ●Lineup

| Output Type       | Open Drain |             | CMOS    |             |
|-------------------|------------|-------------|---------|-------------|
| Detection Voltage | Marking    | Part Number | Marking | Part Number |
| 4.8V              | ZR         | BU4248      | 1H      | BU4348      |
| 4.7V              | ZQ         | BU4247      | 1G      | BU4347      |
| 4.6V              | ZP         | BU4246      | 1F      | BU4346      |
| 4.5V              | ZN         | BU4245      | 1E      | BU4345      |
| 4.4V              | ZM         | BU4244      | 1D      | BU4344      |
| 4.3V              | ZL         | BU4243      | 1C      | BU4343      |
| 4.2V              | ZK         | BU4242      | 1B      | BU4342      |
| 4.1V              | ZJ         | BU4241      | 1A      | BU4341      |
| 4.0V              | ZH         | BU4240      | 0Z      | BU4340      |
| 3.9V              | ZG         | BU4239      | 0Y      | BU4339      |
| 3.8V              | ZF         | BU4238      | 0X      | BU4338      |
| 3.7V              | ZE         | BU4237      | 0W      | BU4337      |
| 3.6V              | ZD         | BU4236      | 0V      | BU4336      |
| 3.5V              | ZC         | BU4235      | 0U      | BU4335      |
| 3.4V              | ZB         | BU4234      | 0T      | BU4334      |
| 3.3V              | ZA         | BU4233      | 0S      | BU4333      |
| 3.2V              | YZ         | BU4232      | 0R      | BU4332      |
| 3.1V              | YY         | BU4231      | 0Q      | BU4331      |
| 3.0V              | YX         | BU4230      | 0P      | BU4330      |
| 2.9V              | YW         | BU4229      | 0N      | BU4329      |
| 2.8V              | YV         | BU4228      | 0M      | BU4328      |
| 2.7V              | YU         | BU4227      | 0L      | BU4327      |
| 2.6V              | YT         | BU4226      | 0K      | BU4326      |
| 2.5V              | YS         | BU4225      | 0J      | BU4325      |
| 2.4V              | YR         | BU4224      | 0H      | BU4324      |
| 2.3V              | YQ         | BU4223      | 0G      | BU4323      |
| 2.2V              | YP         | BU4222      | 0F      | BU4322      |
| 2.1V              | YN         | BU4221      | 0E      | BU4321      |
| 2.0V              | YM         | BU4220      | 0D      | BU4320      |
| 1.9V              | YL         | BU4219      | 0C      | BU4319      |
| 1.8V              | YK         | BU4218      | 0B      | BU4318      |
| 1.7V              | YJ         | BU4217      | 0A      | BU4317      |
| 1.6V              | YH         | BU4216      | ZZ      | BU4316      |
| 1.5V              | YG         | BU4215      | ZY      | BU4315      |
| 1.4V              | YF         | BU4214      | ZX      | BU4314      |
| 1.3V              | YE         | BU4213      | ZW      | BU4313      |
| 1.2V              | YD         | BU4212      | ZV      | BU4312      |
| 1.1V              | YC         | BU4211      | ZU      | BU4311      |
| 1.0V              | YB         | BU4210      | ZT      | BU4310      |
| 0.9V              | YA         | BU4209      | ZS      | BU4309      |

## ● Absolute Maximum Ratings

| Parameter                   |                       | Symbol           | Limit                           | Unit |
|-----------------------------|-----------------------|------------------|---------------------------------|------|
| Power Supply Voltage        |                       | V <sub>DD</sub>  | -0.3 to +7                      | V    |
| Output Voltage              | Nch Open Drain Output | V <sub>OUT</sub> | GND-0.3 to +7                   | V    |
|                             | CMOS Output           |                  | GND-0.3 to V <sub>DD</sub> +0.3 |      |
| Output Current              |                       | I <sub>O</sub>   | 70                              | mA   |
| Power Dissipation           | SSOP5(SOT-23-5) *1*4  | P <sub>d</sub>   | 540                             | mW   |
|                             | SOP4(SC-82) *2*4      |                  | 400                             |      |
|                             | VSOF5 *3*4            |                  | 210                             |      |
| Operation Temperature Range |                       | T <sub>opt</sub> | -40 to +125                     | °C   |
| Ambient Storage Temperature |                       | T <sub>stg</sub> | -55 to +125                     | °C   |

\*1 Reduced by 5.4mW/°C when used over 25°C.

\*2 Reduced by 4.0mW/°C when used over 25°C.

\*3 Reduced by 2.1mW/°C when used over 25°C.

\*4 When mounted on ROHM standard circuit board (70mm×70mm×1.6mm, glass epoxy board).

## ● Electrical Characteristics (Unless Otherwise Specified Ta=-25 to 125°C)

| Parameter                   | Symbol           | Condition                                                                          | Limit                         |                      |                               | Unit |
|-----------------------------|------------------|------------------------------------------------------------------------------------|-------------------------------|----------------------|-------------------------------|------|
|                             |                  |                                                                                    | Min.                          | Typ.                 | Max.                          |      |
| Detection Voltage           | V <sub>DET</sub> | V <sub>DD</sub> =H→L, Ta=25°C, R <sub>L</sub> =470kΩ                               | V <sub>DET</sub> (T)<br>×0.99 | V <sub>DET</sub> (T) | V <sub>DET</sub> (T)<br>×1.01 | V    |
|                             |                  | V <sub>DET</sub> =1.8V                                                             | Ta=+25°C                      | 1.782                | 1.8                           |      |
|                             |                  |                                                                                    | Ta=-40°C to 85°C              | 1.741                | -                             |      |
|                             |                  |                                                                                    | Ta=85°C to 125°C              | 1.718                | -                             |      |
|                             |                  | V <sub>DET</sub> =2.5V                                                             | Ta=+25°C                      | 2.475                | 2.5                           |      |
|                             |                  |                                                                                    | Ta=-40°C to 85°C              | 2.418                | -                             |      |
|                             |                  |                                                                                    | Ta=85°C to 125°C              | 2.386                | -                             |      |
|                             |                  | V <sub>DET</sub> =3.0V                                                             | Ta=+25°C                      | 2.970                | 3.0                           |      |
|                             |                  |                                                                                    | Ta=-40°C to 85°C              | 2.901                | -                             |      |
|                             |                  |                                                                                    | Ta=85°C to 125°C              | 2.864                | -                             |      |
|                             |                  | V <sub>DET</sub> =3.3V                                                             | Ta=+25°C                      | 3.267                | 3.3                           |      |
|                             |                  |                                                                                    | Ta=-40°C to 85°C              | 3.191                | -                             |      |
|                             |                  |                                                                                    | Ta=85°C to 125°C              | 3.150                | -                             |      |
| Circuit Current when ON     | I <sub>DD1</sub> | V <sub>DD</sub> =V <sub>DET</sub> -0.2V                                            | V <sub>DET</sub> =0.9 to 1.3V | -                    | 0.15                          | μA   |
|                             |                  |                                                                                    | V <sub>DET</sub> =1.4 to 2.1V | -                    | 0.20                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =2.2 to 2.7V | -                    | 0.25                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =2.8 to 3.3V | -                    | 0.30                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =3.4 to 4.2V | -                    | 0.35                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =4.3 to 4.8V | -                    | 0.40                          |      |
| Circuit Current when OFF    | I <sub>DD2</sub> | V <sub>DD</sub> =V <sub>DET</sub> +2.0V                                            | V <sub>DET</sub> =0.9 to 1.3V | -                    | 0.30                          | μA   |
|                             |                  |                                                                                    | V <sub>DET</sub> =1.4 to 2.1V | -                    | 0.35                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =2.2 to 2.7V | -                    | 0.40                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =2.8 to 3.3V | -                    | 0.45                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =3.4 to 4.2V | -                    | 0.50                          |      |
|                             |                  |                                                                                    | V <sub>DET</sub> =4.3 to 4.8V | -                    | 0.55                          |      |
| Operating Voltage Range     | V <sub>OPL</sub> | V <sub>OL</sub> ≤0.4V, Ta=25 to 125°C, R <sub>L</sub> =470kΩ                       | 0.70                          | -                    | -                             | V    |
|                             |                  | V <sub>OL</sub> ≤0.4V, Ta=-40 to 25°C, R <sub>L</sub> =470kΩ                       | 0.90                          | -                    | -                             |      |
| 'High' Output Voltage (Pch) | V <sub>OH</sub>  | V <sub>DD</sub> =4.8V, I <sub>SOURCE</sub> =1.7 mA, V <sub>DET</sub> =0.9V to 3.9V | V <sub>DD</sub> -0.5          | -                    | -                             | V    |
|                             |                  | V <sub>DD</sub> =6.0V, I <sub>SOURCE</sub> =2.0 mA, V <sub>DET</sub> =4.0V to 4.8V | V <sub>DD</sub> -0.5          | -                    | -                             | V    |
| 'Low' Output Voltage (Nch)  | V <sub>OL</sub>  | V <sub>DD</sub> =0.85V, I <sub>SINK</sub> =20 μA                                   | -                             | -                    | 0.05                          | V    |
|                             |                  | V <sub>DD</sub> =1.5V, I <sub>SINK</sub> =1 mA, V <sub>DET</sub> =1.7 to 4.8V      | -                             | -                    | 0.5                           | V    |
|                             |                  | V <sub>DD</sub> =2.4V, I <sub>SINK</sub> =3.6 mA, V <sub>DET</sub> =2.7 to 4.8V    | -                             | -                    | 0.5                           |      |

\*1: Design Guarantee. (Outgoing inspection is not done on all products.)

V<sub>DET</sub>(T): Standard Detection Voltage (0.9V to 4.8V, 0.1V step)R<sub>L</sub>: Pull-up resistor to be connected between V<sub>out</sub> and power supply.

## ●Electrical Characteristics (Unless Otherwise Specified Ta=-25 to 125°C) - continued

| Parameter                                 | Symbol             | Condition                                          | Limit        |               |               | Unit    |
|-------------------------------------------|--------------------|----------------------------------------------------|--------------|---------------|---------------|---------|
|                                           |                    |                                                    | Min.         | Typ.          | Max.          |         |
| Leak Current when OFF                     | $I_{leak}$         | VDD=VDS=7V Ta=-40 to 85°C                          | -            | 0             | 0.1           | $\mu A$ |
|                                           |                    | VDD=VDS=7V Ta=85 to 125°C                          | -            | 0             | 1             |         |
| CT pin Threshold Voltage                  | $V_{CTH}$          | VDD=VDET×1.1, VDET=0.9 to 2.5V Ta=25°C<br>RL=470kΩ | VDD<br>×0.35 | VDD<br>×0.45  | VDD<br>×0.55  | V       |
|                                           |                    | VDD=VDET×1.1, VDET=2.6 to 4.8V Ta=25°C<br>RL=470kΩ | VDD<br>×0.40 | VDD<br>×0.50  | VDD<br>×0.60  |         |
| Output Delay Resistance                   | $R_{CT}$           | VDD=VDET×1.1 VCT=0.5V Ta=25°C *1                   | 9            | 10            | 11            | MΩ      |
| CT pin Output Current                     | $I_{CT}$           | VCT=0.1V VDD=0.85V                                 | 5            | 40            | -             | $\mu A$ |
|                                           |                    | VCT=0.5V VDD=1.5V VDET=1.7 to 4.8V                 | 200          | 400           | -             |         |
| Detection Voltage Temperature coefficient | $V_{DET}/\Delta T$ | Ta=-40°C to 125°C                                  | -            | ±30           | -             | ppm/°C  |
| Hysteresis Voltage                        | $\Delta V_{DET}$   | VDD=L→H→L<br>Ta=-40 to 125°C<br>RL=470kΩ           | VDET≤1.0V    | VDET<br>×0.03 | VDET<br>×0.05 | V       |
|                                           |                    |                                                    | VDET≥1.1V    | VDET<br>×0.03 | VDET<br>×0.05 |         |

\*1: Design Guarantee. (Outgoing inspection is not done on all products.)

VDET(T): Standard Detection Voltage (0.9V to 4.8V, 0.1V step)

RL: Pull-up resistor to be connected between VOUT and power supply.

●Block Diagrams

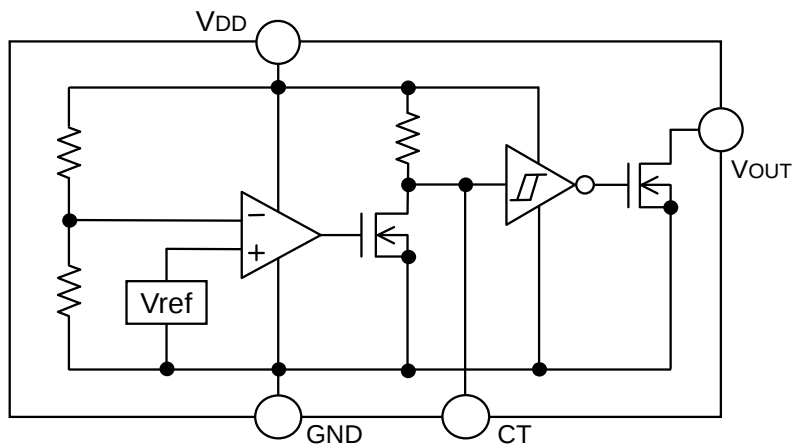


Fig.1 BU42xx Series

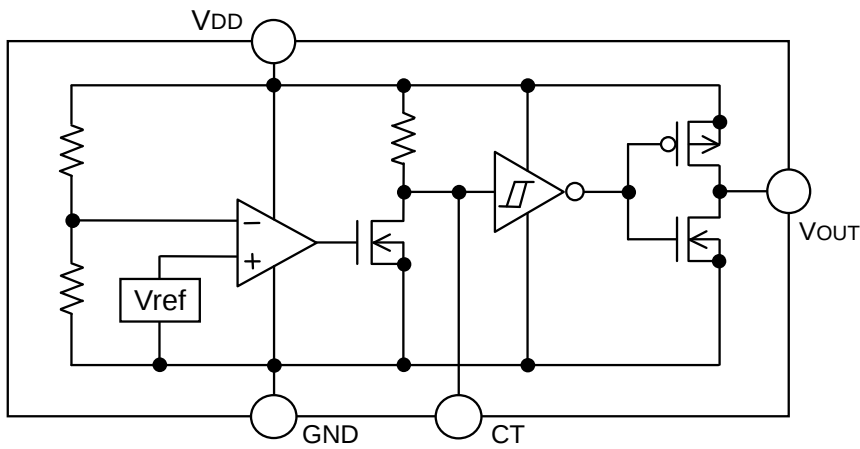
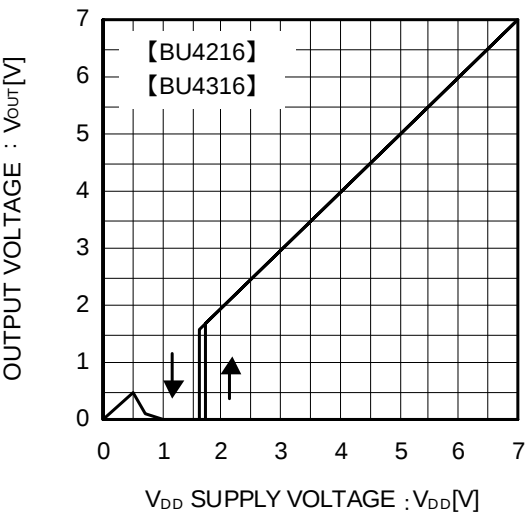
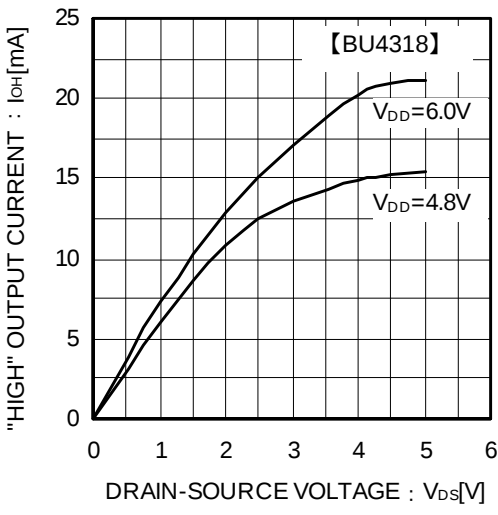
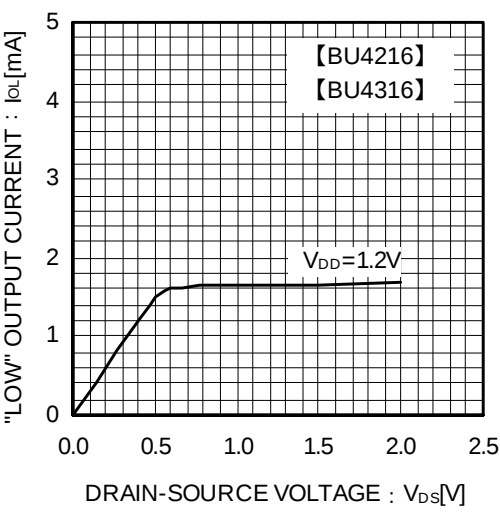


Fig.2 BU43xx Series

●Typical Performance Curves



●Typical Performance Curves – continued



●Typical Performance Curves – continued



Fig.11 Circuit Current when OFF



Fig.12 Operating Limit Voltage

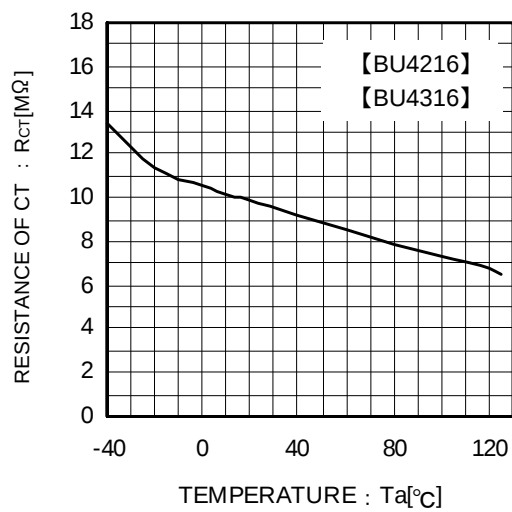


Fig.13  $C_T$  Terminal Circuit Resistance

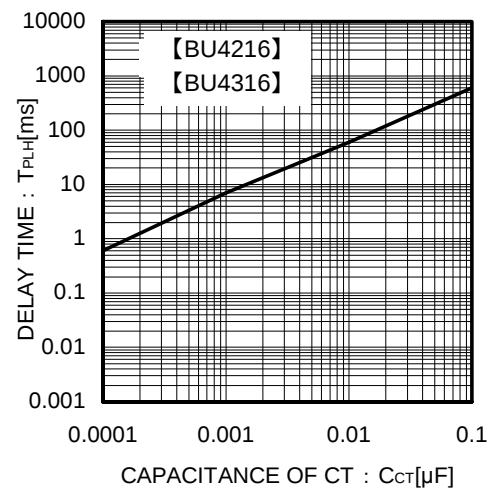


Fig.14 Delay Time ( $t_{PLH}$ ) and  $C_T$  Terminal External Capacitance

## ● Application Information

### Explanation of Operation

For both the open drain type (Fig.15) and the CMOS output type (Fig.16), the detection and release voltages are used as threshold voltages. When the voltage applied to the VDD pins reaches the applicable threshold voltage, the Vout terminal voltage switches from either "High" to "Low" or from "Low" to "High". BU42xx and BU43xx series have delay time function which set t<sub>PLH</sub> (Output "Low"→"High") using an external capacitor (C<sub>CT</sub>). Because the BU42xx series uses an open drain output type, it is necessary to connect a pull-up resistor to VDD or another power supply if needed [The output "High" voltage (V<sub>OUT</sub>) in this case becomes VDD or the voltage of the other power supply].

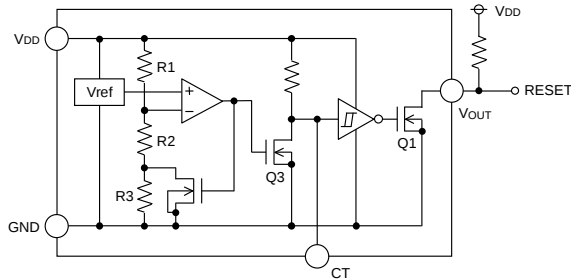


Fig.15 (BU42xx series Internal Block Diagram)



Fig.16 (BU43xx type Internal Block Diagram)

### Setting of Detector Delay Time

The delay time of this detector IC can be set at the rise of VDD by the capacitor connected to C<sub>T</sub> terminal.

Delay time at the rise of VDD t<sub>PLH</sub>: Time until when V<sub>OUT</sub> rises to 1/2 of VDD after VDD rises up and beyond the release voltage (V<sub>DET</sub>+ΔV<sub>DET</sub>)

$$T_{PLH} = -1 \times C_{CT} \times R_{CT} \times \ln \left( \frac{V_{DD} - V_{CTH}}{V_{DD}} \right)$$

C<sub>CT</sub>: C<sub>T</sub> pin Externally Attached Capacitance  
R<sub>CT</sub>: C<sub>T</sub> pin Internal Impedance (P.3 R<sub>CT</sub> refer.)

V<sub>CTH</sub>: C<sub>T</sub> pin Threshold Voltage (P.3 V<sub>CTH</sub> refer.)  
ln: Natural Logarithm

### Reference Data of Falling Time (t<sub>PHL</sub>) Output

Examples of Falling Time (t<sub>PHL</sub>) Output

| Part Number | t <sub>PHL</sub> [μs] |
|-------------|-----------------------|
| BU4245      | 275.7                 |
| BU4345      | 359.3                 |

\* This data is for reference only.

The figures will vary with the application, so please confirm the actual operating conditions before use.

### Timing Waveforms

Example: The following shows the relationship between the input voltage VDD, the C<sub>T</sub> Terminal Voltage V<sub>CT</sub> and the output voltage V<sub>OUT</sub> when the input power supply voltage VDD is made to sweep up and sweep down (The circuits are shown in Fig.15 and 16).



Fig.17 Timing Waveforms

- ① When the power supply is turned on, the output is unstable from after over the operating limit voltage (V<sub>OPL</sub>) until t<sub>PLH</sub>. Therefore, it is possible that the reset signal is not outputted when the rise time of VDD is faster than t<sub>PLH</sub>.
- ② When VDD is greater than V<sub>OPL</sub> but less than the reset release voltage (V<sub>DET</sub>+ΔV<sub>DET</sub>), the C<sub>T</sub> terminal (V<sub>CT</sub>) and output (V<sub>OUT</sub>) voltages will switch to L.
- ③ If VDD exceeds the reset release voltage (V<sub>DET</sub>+V<sub>DET</sub>), then V<sub>OUT</sub> switches from L to H (with a delay to the C<sub>T</sub> terminal).
- ④ If VDD drops below the detection voltage (V<sub>DET</sub>) when the power supply is powered down or when there is a power supply fluctuation, V<sub>OUT</sub> switches to L (with a delay of t<sub>PHL</sub>).
- ⑤ The potential difference between the detection voltage and the release voltage is known as the hysteresis width (V<sub>DET</sub>). The system is designed such that the output does not toggle with power supply fluctuations within this hysteresis width, preventing malfunctions due to noise.

## ●Circuit Applications

### 1) Examples of common power supply detection reset circuits

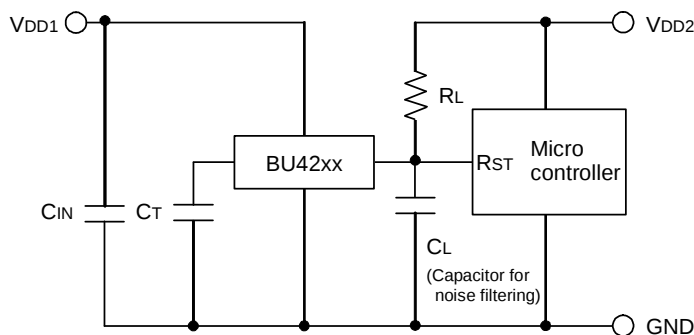


Fig.18 Open Drain Output type

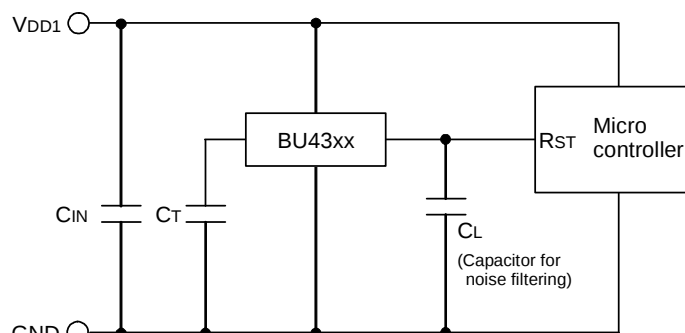


Fig.19 CMOS Output type

Application examples of BU42xx series (Open Drain output type) and BU43xx series (CMOS output type) are shown below.

CASE1: Power supply of microcontroller ( $V_{DD2}$ ) differs from the power supply of the reset detection ( $V_{DD1}$ ). Use an open drain output Type (BU42xx series) device with a load resistance  $R_L$  as shown Fig.18.

CASE2: Power supply of microcontroller ( $V_{DD1}$ ) is the same as the power supply of the reset detection ( $V_{DD1}$ ). Use a CMOS output type (BU43xx series) device or an open drain output type (BU42xx series) device with a pull up resistor between the output and  $V_{DD1}$ .

When a capacitance  $C_L$  for noise filtering is connected to  $V_{OUT}$  pin (the reset signal input terminal of the microcontroller), please take into account the waveform of the rise and fall time of the output voltage ( $V_{OUT}$ ).

### 2) The following is an example of a circuit application in which an OR connection between two types of detection voltage resets the microcontroller.



Fig.20

To reset the microcontroller when many independent power supplies are used in the system, OR connect an open drain output type (BU42xx series) to the microcontroller's input with pull-up resistor to the supply voltage of the microcontroller ( $V_{DD3}$ ) as shown in Fig. 20. By pulling-up to  $V_{DD3}$ , output "High" voltage of micro-controller power supply is possible.

### 3) Examples of the power supply with resistor dividers

In applications wherein the power supply input terminal (VDD) of an IC has resistor dividers, it is possible that an in-rush current will momentarily flow into the circuit when the output logic switches, resulting in malfunctions (such as output oscillations).

(In-rush current is a current that momentarily flows from the power supply (VDD) to ground (GND) when the output level switches from "High" to "Low" or vice versa.)

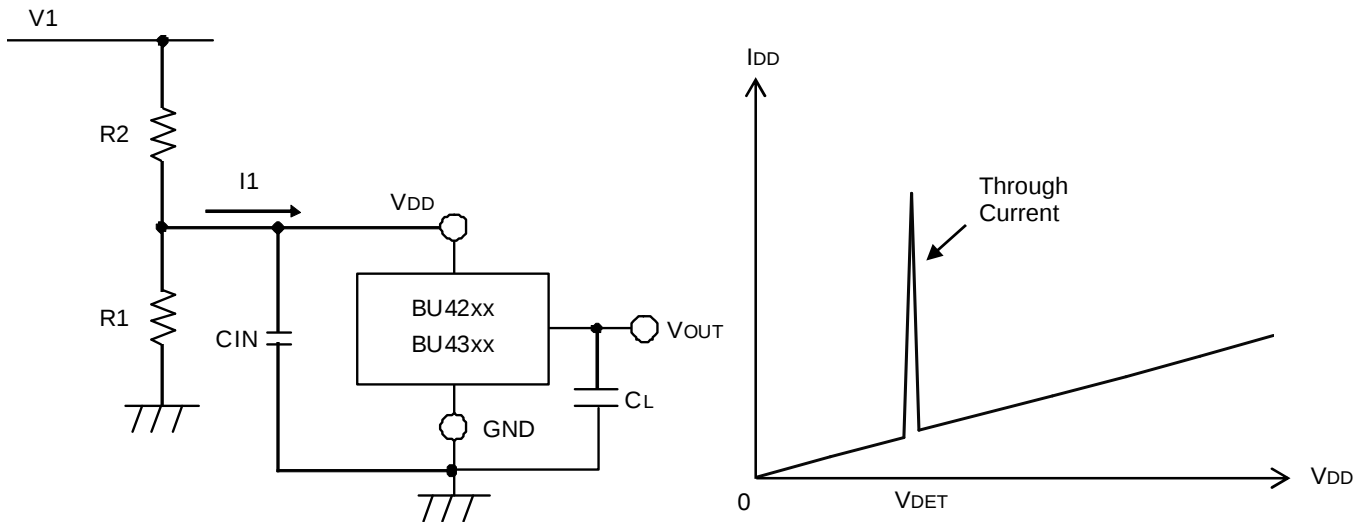


Fig.21

A voltage drop [in-rush current ( $I_1$ )]  $\times$  [input resistor ( $R_2$ )] is caused by the in-rush current, and causes the input voltage to drop when the output switches from "Low" to "High". When the input voltage decreases and falls below the detection voltage, the output voltage switches from "High" to "Low". At this time, the in-rush current stops flowing through output "Low", and the voltage drop is reduced. As a result, the output switches from "Low" to "High", which again causes the in-rush current to flow and the voltage to drop. This operation repeats and will result to oscillation.

Consider the use of BD52xx when the power supply input has resistor dividers.



Fig.22 Current Consumption vs. Power Supply Voltage

\* This data is for reference only.

The figures will vary with the application, so please confirm the actual operating conditions before use.

## ●Operational Notes

- 1) Absolute maximum ratings  
Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.
- 2) Ground Voltage  
The voltage of the ground pin must be the lowest voltage of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.
- 3) Recommended operating conditions  
These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.
- 4) Bypass Capacitor for Noise Rejection  
To help reject noise, put a 1 $\mu$ F capacitor between V<sub>DD</sub> pin and GND and 1000pF capacitor between V<sub>OUT</sub> pin and GND. Be careful when using extremely big capacitor as transient response will be affected.
- 5) Short between pins and mounting errors  
Be careful when mounting the IC on printed circuit boards. The IC may be damaged if it is mounted in a wrong orientation or if pins are shorted together. Short circuit may be caused by conductive particles caught between the pins.
- 6) Operation under strong electromagnetic field  
Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.
- 7) The V<sub>DD</sub> line impedance might cause oscillation because of the detection current.
- 8) A V<sub>DD</sub> to GND capacitor (as close connection as possible) should be used in high V<sub>DD</sub> line impedance condition.
- 9) Lower than the minimum input voltage puts the V<sub>OUT</sub> in high impedance state, and it must be V<sub>DD</sub> in pull up (V<sub>DD</sub>) condition.
- 10) External parameters  
The case of needless "Delay Time", recommended to insert more 470k $\Omega$  resistor between V<sub>DD</sub> and C<sub>T</sub>. The recommended value of R<sub>L</sub> Resistor is over 50k $\Omega$  to 1M $\Omega$  for V<sub>DET</sub>=1.5V to 4.8V, and over 100k $\Omega$  to 1M $\Omega$  for V<sub>DET</sub>=0.9V to 1.4V. The recommended value of C<sub>T</sub> Capacitor is over 100pF to 0.1 $\mu$ F. There are many factors (board layout, etc) that can affect characteristics. Please verify and confirm using practical applications.
- 11) Power on reset operation  
Please note that the power on reset output varies with the V<sub>DD</sub> rise time. Please verify the behavior in the actual operation.
- 12) Testing on application boards  
When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.
- 13) Rush current  
When power is first supplied to the IC, rush current may flow instantaneously. It is possible that the charge current to the parasitic capacitance of internal photo diode or the internal logic may be unstable. Therefore, give special consideration to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.
- 14) C<sub>T</sub> pin discharge  
Due to the capabilities of the C<sub>T</sub> pin discharge transistor, the C<sub>T</sub> pin may not completely discharge when a short input pulse is applied, and in this case the delay time may not be controlled. Please verify the actual operation.
- 15) This IC has extremely high impedance terminals. Small leak current due to the uncleanness of PCB surface might cause unexpected operations. Application values in these conditions should be selected carefully. If 10M $\Omega$  leakage is assumed between the C<sub>T</sub> terminal and the GND terminal, 1M $\Omega$  connection between the CT terminal and the V<sub>DD</sub> terminal would be recommended. Also, if the leakage is assumed between the Vout terminal and the GND terminal, the pull up resistor should be less than 1/10 of the assumed leak resistance. The value of R<sub>CT</sub> depends on the external resistor that is connected to C<sub>T</sub> terminal, so please consider the delay time that is decided by  $t \times R_{CT} \times C_{CT}$  changes.

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|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV  |           | CLASS III  |           |

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  - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - Sealing or coating our Products with resin or other coating materials
  - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
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## Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
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  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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